



Microsemi[®]

UM7000 / UM7100 / UM7200

HIGH POWER PIN DIODES

RoHS Compliant Versions Available



DESCRIPTION

The UM7000 and UM7100 series offer moderately high power handling in combination with reasonably low levels of both series resistance and capacitance. The UM7200 series offers the lowest series resistance, but the highest capacitance of the group. The differences in specified performance for each of the series, results from different I-region thickness. The three series have broad applicability in many RF and microwave switch and attenuator circuits. Additionally, the UM7100 in leaded versions is usually the most cost-effective diode choice in high volume usage.

IMPORTANT:

For the most current data, consult MICROSEMI's website: www.MICROSEMI.com

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

Package	Conditions	(P _D) Power Dissipation (W)	(θ) Thermal Resistance (°C/W)
A	25 °C Pin Temperature	10	15V
B	½ in. total length to 25 °C Contact Free Air	5.5	27.5
E		1.5	
C	25 °C Stud Temperature	10	15
D	25 °C Stud Temperature	7.5	20
SM	25 °C End Cap Temperature	8	17
ALL	1 us pulse (Single)	100KW	60 kW 35 kW 20 kW
ALL	Storage Temperature (T _{OP})	-65 °C to + 175 °C	
ALL	Operating Temperature (T _{OP})	-65 °C to + 175 °C	

KEY FEATURES

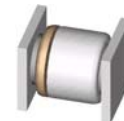
- Voltage ratings to 1000V (UM7000)
- Average power dissipation to 10 W
- Series resistance as low as 0.25 Ω
- Carrier lifetime greater than 2.5 μ s
- Low capacitance
- Low conductance (High R_p)
- Compatible with automated assembly
- RoHS compliant packaging Available¹
(Use UM7202B, etc.)

¹ The UM7000 series of products can be supplied with a RoHS compliant finish (UMX7000) or with a 90/10 Sn/Pb finish. Stud Packages C/CR/D/DR are supplied with a RoHS complaint Gold finish Consult factory for details.



APPLICATIONS/BENEFITS

- Isolated stud package available
- Surface mount package available
- Soldering temperature: 260 °C for 10 seconds maximum



VOLTAGE RATINGS
@ 25°C (unless otherwise specified)

Part Number			Reverse Voltage @ 10uA (V)
UM7001	UM7101	UM7201	100
UM7002	UM7102	UM7202	200
-	UM7104	UM7204	400
UM7006	-	-	600
-	UM7108	-	800
UM7010	-	-	1000

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)

Parameter	Symbol	Conditions	UM7000	UM7100	UM7200	Units
Reverse Current (Max)	I_R	At rated voltage	10	10	10	uA
Series Resistance(Max)	R_S	$I_F = 100 \text{ mA}$, $F = 100 \text{ MHz}$	1.0	0.6	0.25	Ohm
Capacitance (Max)	C_T	$V_R = 100 \text{ V}$, $F = 1 \text{ MHz}$	0.9	1.2	2.2	pF
Parallel Resistance(Min)	R_P	$V_R = 100 \text{ V}$, $F = 100 \text{ MHz}$	200k	150k	70k	Ohms
Carrier Lifetime(Min)	T_L	$I_F = 10 \text{ mA}$	2.5	2.0	1.5	uS
I-Region Width (Min)	W	-	150	80	40	um

See following pages for performance graphs and mechanical data.



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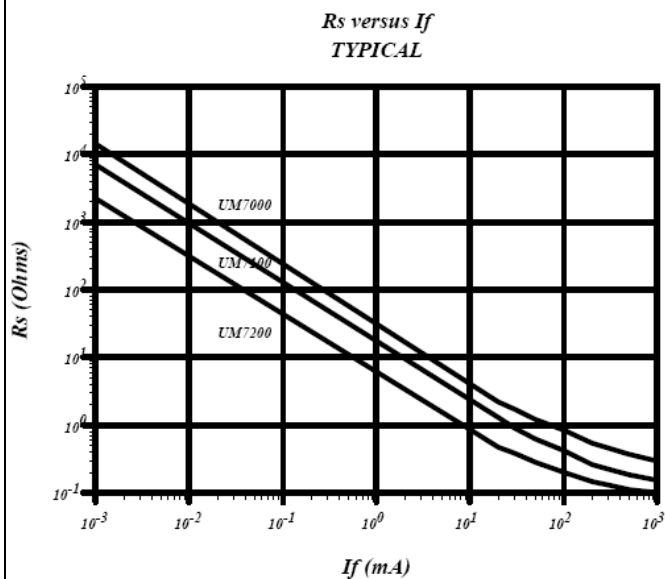
UM7000 / UM7100 / UM7200

HIGH POWER PIN DIODES

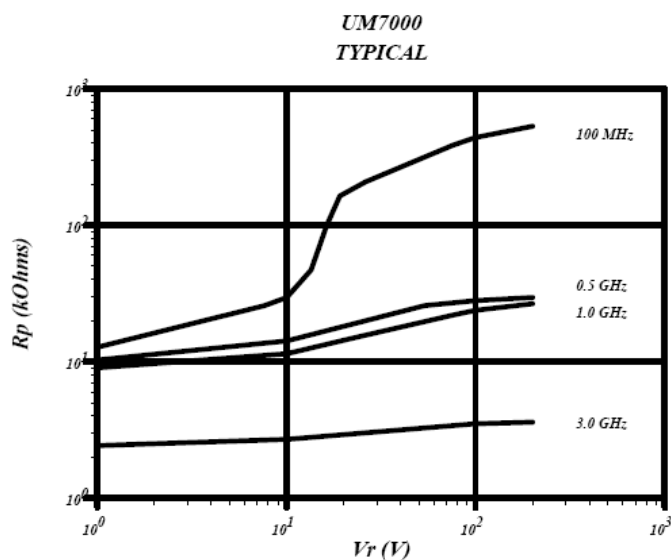
RoHS Compliant Versions Available



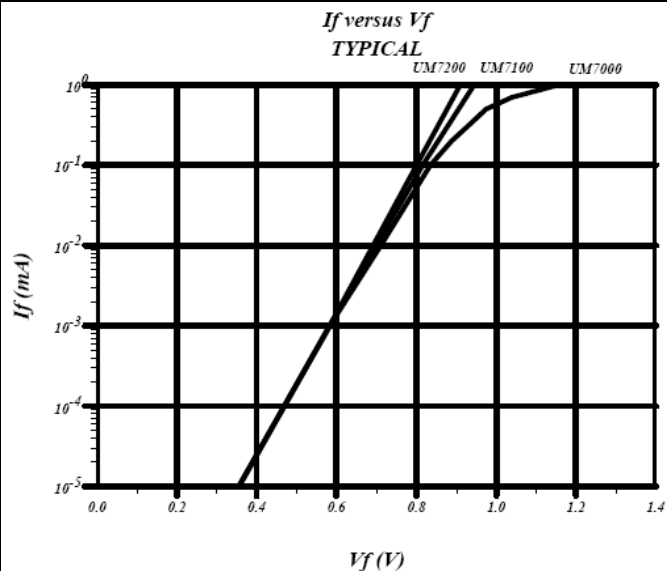
TYPICAL R_S VS I_F



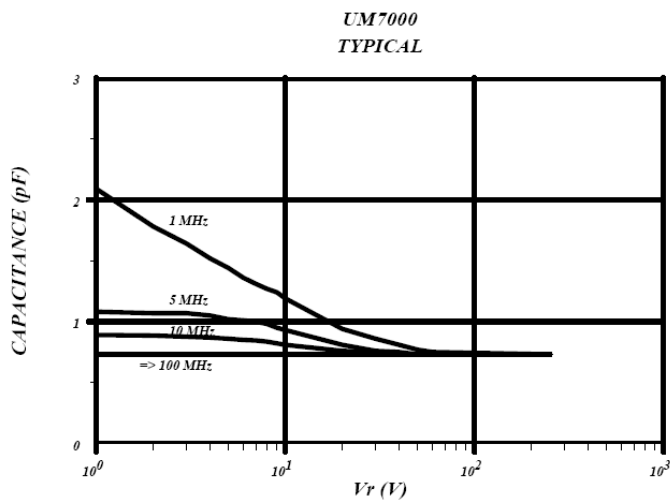
TYPICAL R_P VS VOLTAGE



I_F VS V_F



CAPACITANCE VS VOLTAGE





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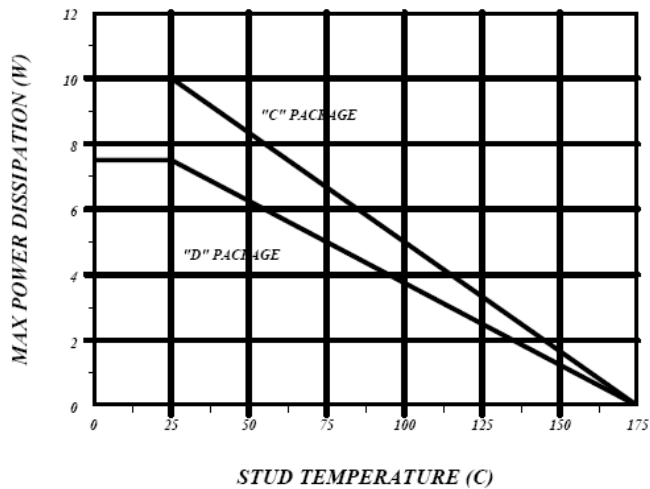
HIGH POWER PIN DIODES

RoHS Compliant Versions Available



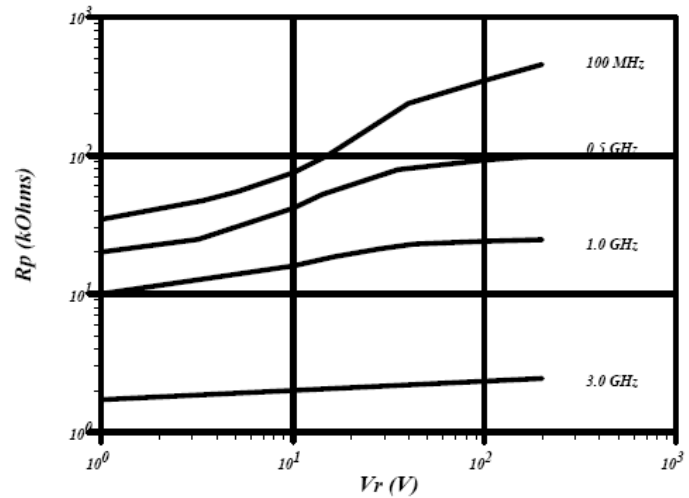
POWER RATING

POWER RATING STUD MOUNTED DIODES
TYPICAL



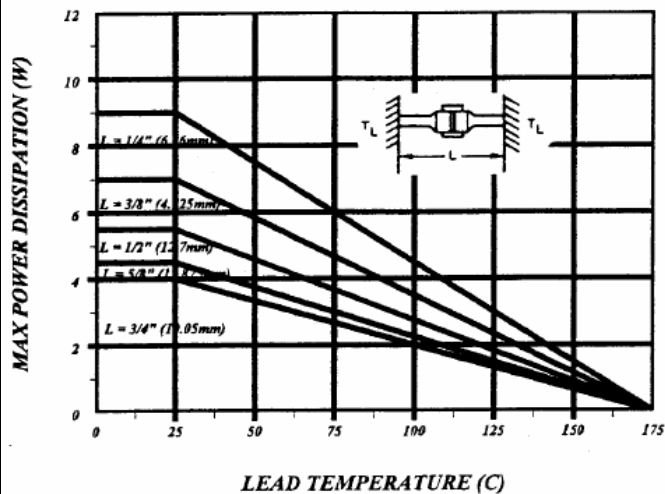
TYPICAL RP VS VOLTAGE

UM7100
TYPICAL



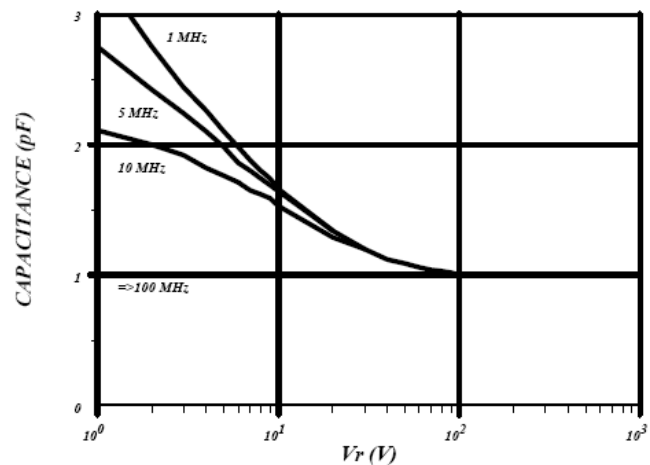
POWER RATING

POWER RATING AXIAL LEADED DIODES
TYPICAL



CAPACITANCE VS VOLTAGE

UM7100
TYPICAL



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GRAPHS



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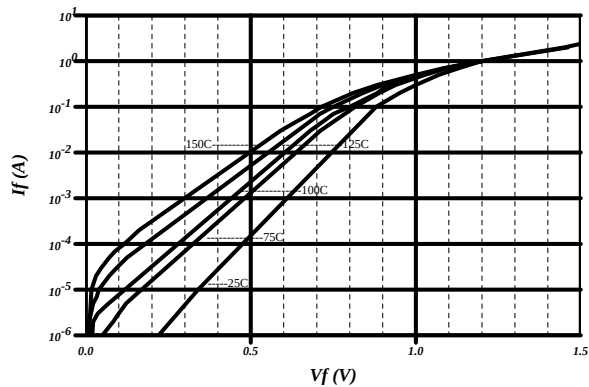
HIGH POWER PIN DIODES

RoHS Compliant Versions Available



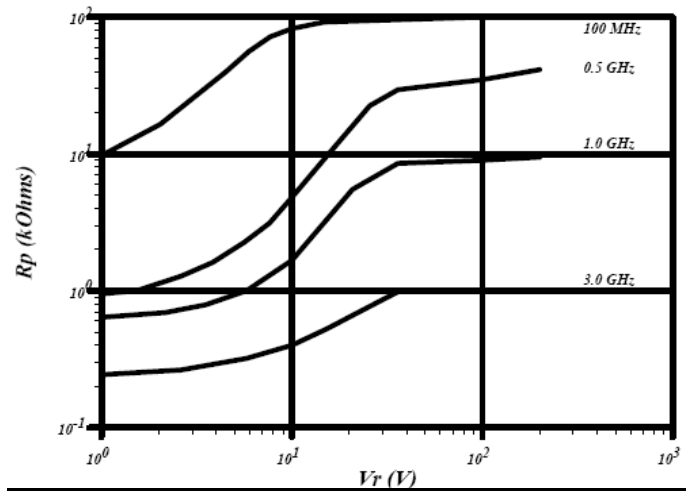
I/V VS TEMP

MEAN I_f VERSUS V_f CURVE VERSUS TEMPERATURE
TYPICAL



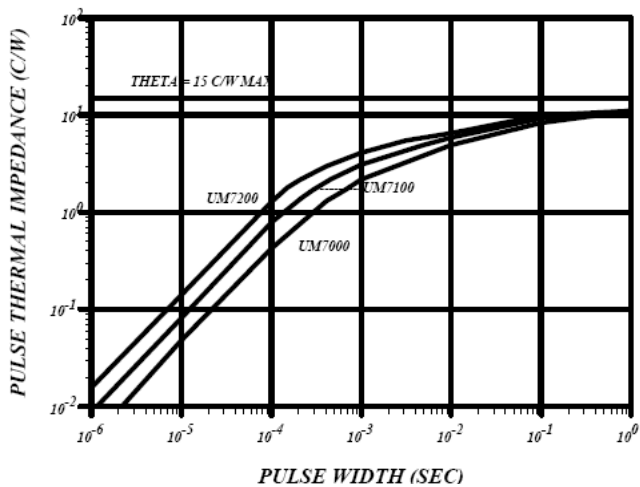
TYPICAL R_p VS VOLTAGE

UM7200
TYPICAL



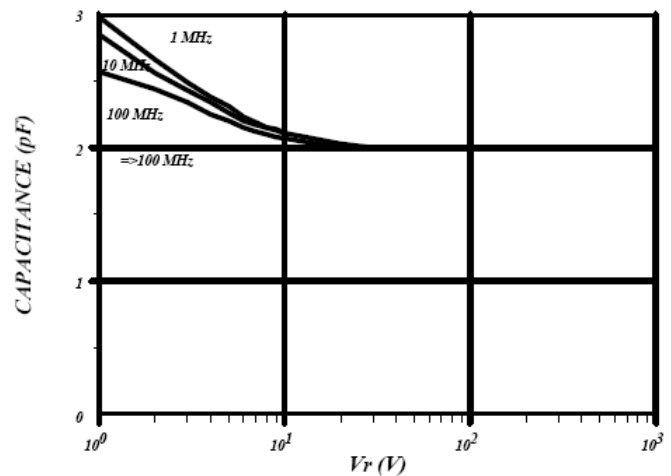
THERMAL IMPEDANCE

PULSE THERMAL IMPEDANCE VERSUS WIDTH
TYPICAL



CAPACITANCE VS VOLTAGE

UM7200
TYPICAL





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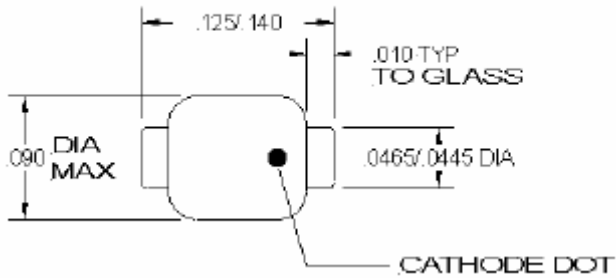
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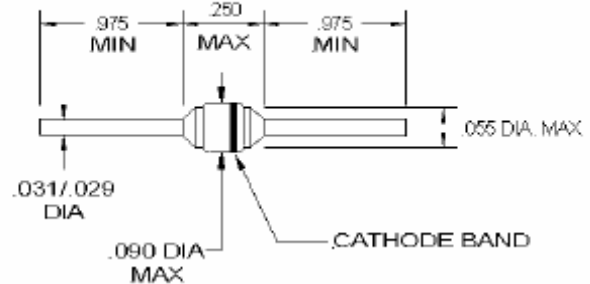
PACKAGE STYLE 'A'

STYLE "A"



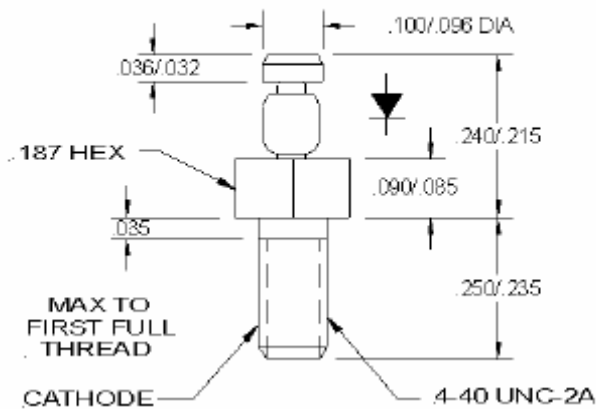
PACKAGE STYLE 'B'

STYLE "B"



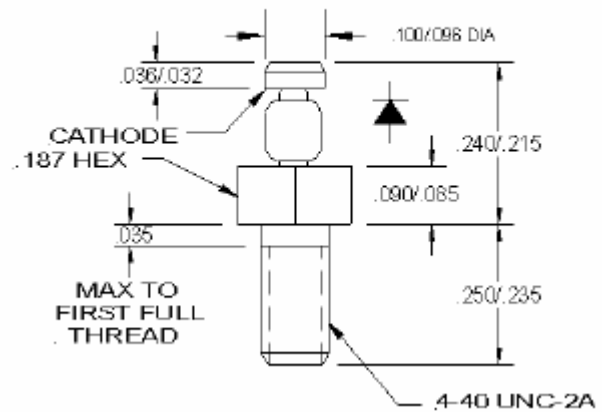
PACKAGE STYLE 'C'

STYLE "C"

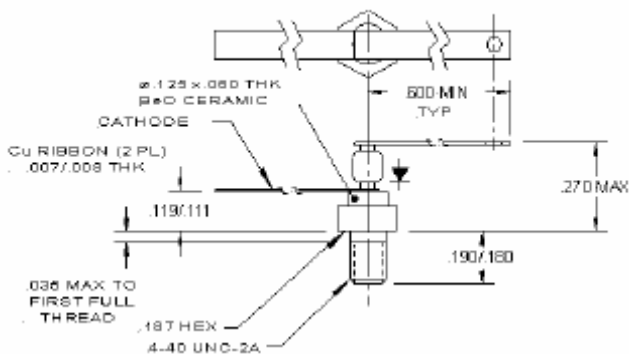


PACKAGE STYLE 'CR'

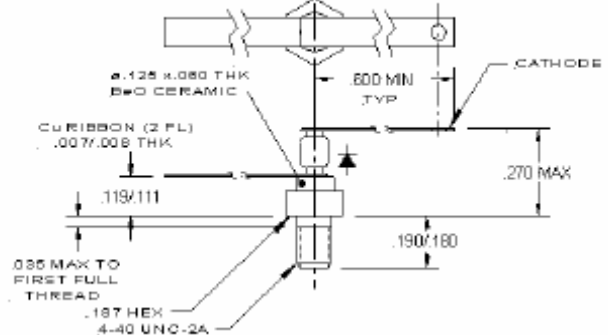
STYLE "CR"



PACKAGE STYLE 'D'



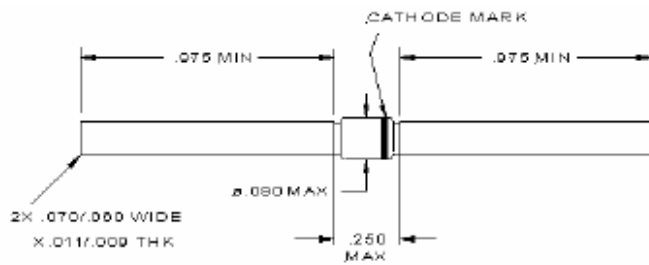
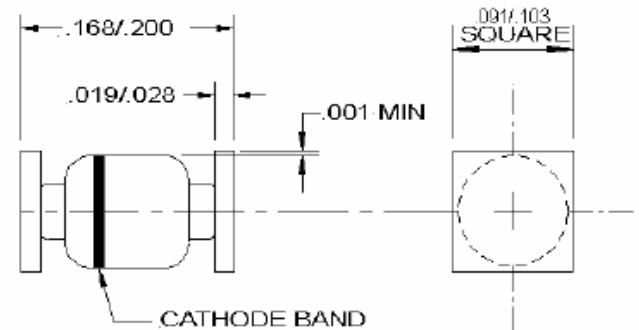
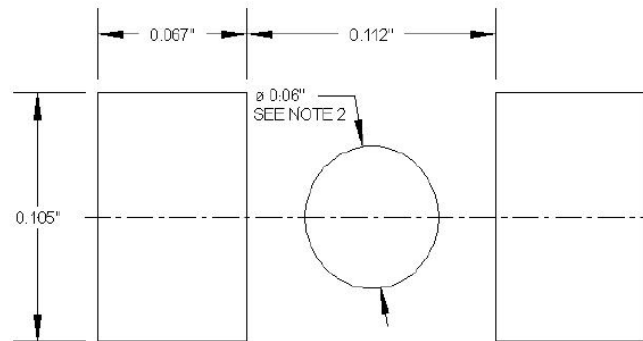
PACKAGE STYLE 'DR'



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MECHANICAL

RoHS Compliant Versions Available


PACKAGE STYLE 'E'

PACKAGE STYLE 'SM'

STYLE 'SM' FOOTPRINT

NOTES:

- 1 These dimensions will match the terminals and provide for additional solder fillets at the outboard ends at least as wide as the terminals themselves, assuming accuracy of placement within 0.005"
- 2 If the mounting method chosen requires use of an adhesive separate from the solder compound, a round (or square) spot of cement as shown should be centrally located.